

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10749103
<b>Filing Date:</b>	30-Dec-2003
<b>Title of Invention:</b>	Method of forming a multi-layer semiconductor structure incorporating a processing handle member
<b>First Named Inventor:</b>	Rafael Reif
<b>Filer:</b>	Christopher S. Daly/Trish McHugh
<b>Attorney Docket Number:</b>	MIT-136BUS

Filed as Small Entity

### **Utility Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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**Basic Filing:**

**Pages:**

**Claims:**

**Miscellaneous-Filing:**

**Petition:**

**Patent-Appeals-and-Interference:**

Post-Allowance-and-Post-Issuance:

**Extension-of-Time:**

Extension - 3 months with \$0 paid	2253	1	510	510
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>510</b>